

# **SPECIFICATION**

# 宏致電子股份有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Jhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808 FAX: +886-3-463-1800

SPEC. NO.:	PS-912	235-XXXXX-001	REVISION:	E
PRODUCT N	NAME:	2.2mm PITCH WTB \	WAFER CONN.	
PRODUCT N	NO:	91235-XXXXX-001 / 9	91235/92235 / 92237 /	92410 / 92239

PREPARED:

CHECKED:

APPROVED:

Lee Kuang En

Chen Chi Chang

DATE:

2018/10/17

DATE:

2018/10/17

DATE:

2018/10/17



TITLE: 2.2MM PITCH WTB WAFER CONN.

 RELEASE DATE: 2018.10.17
 REVISION: E
 ECN No: 1811330
 PAGE: 2 OF 9

 1
 REVISION HISTORY
 3

 2
 SCOPE
 4

 3
 APPLICABLE DOCUMENTS
 4

 4
 REQUIREMENTS
 4

 5
 PERFORMANCE
 5

 6
 PRODUCT QUALIFICATION AND TEST SEQUENCE
 11



TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: **3** OF **9** 

## 1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
1	ECN-1409068	NEW SPEC	LERRY	14'/10/08
2	ECN-1411024	Re-define test sequence.in P9	LERRY	14'/11/25
0	ECN-1504012	Re-define test sequence.in P6	LERRY	15'/04/01
Α	ECN-1507435	Merge SPEC(91235 series/92235series)	LERRY	15'/08/03
В	ECN-1605504	The new series (92237)	XUYNANG YANG	16'/05/30
С	ECN-1703135	新增 92237 獨立插入拔出力規格	Jay	17'/03/14
D	ECN-1806236	Added 92235-032 Plug and Pull Force SPEC.	CCHEN	18/06/15
E	ECN-1811330	Add CTS-17.01.03-A1-2016 SPEC.AND Increase P/N 92410(Housing)&92507(Terminal)FOR CTS	Bernie	18'/10/17



TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: 4 OF 9

#### 2 SCOPE

This specification covers performance, tests and quality requirements for 2.2mm Pitch WTB Wafer Conn...

#### 3 APPLICABLE DOCUMENTS

3-1 EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

3-2 NDS05

3-3 CTS-17.01.03-A1-2016

3.3.1 QC/T 413—2002

3.3.2 QC/T 417.1—2001 (ISO 8092.2)

### 4 REQUIREMENTS

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy (Brass)

Finish: (a) Contact Area: Tin plated.

(b) Under plate: Nickel-plated overall.

- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-HB
- 4.2.3 Terminal: High performance copper alloy
- 4.3 Ratings
  - 4.3.1 Voltage: 13±1 Volts DC (per pin)
  - 4.3.2 Current: 4 Amperes (per pin)
  - 4.3.3 Operating Temperature : -40°C to +105°C
  - 4.3.4 Normal humidity:60±15%



TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: **5** OF **9** 

### 5 Performance

## 5.1. Test Requirements and Procedures Summary

Item		Requiren	nent	Standard				
Examination of Pro	duct	Product shall meet of applicable product and specification.	requirements ct drawing	Visual, dimensional and functional per applicable quality inspection plan.				
Hand feeling	Ī	There is no obvious such a touch.	blocking or	Insert and drag the terminal, sheath and connector with the hand and check the tactile				
			ELECTF	RICAL				
Item		Require	ment	Standard				
	Туре		TH TH-NH	1.Energize the following circuits at the 15V voltages and 6A currents with the male and female connectors fitted. After the amount of voltage drop is stabled at a distance of 100mm away from the crimped section,				
	Initia	l value	10 or less	measure the voltage drop. Subtracting the wire				
Voltage Drop	After	the durability test	30 or less	resistance of 100mm,determine the contact resistance.				
	Initial v	e electric current circuit: value and value sfter irability test	30 or less	2.Wire size[mm²] : 0.3 ;Electric resistance[m $\Omega$ /m] : 50.2				
	Unit r	m V/A		SEE Fig1 \ 2 (NDS05-3.2.1, DATE:JUN.14.2008)				
The bending strength of After 15s,the termiterminal torn apart		inal can't be	This test is only applicable to the common terminal, Fix the end of the press, pressing the position up, as shown in figure 2, apply 15N force along the diagram and then release after 15s, the terminal were then rotated 180° and 90° respectively. Fig. 3 (CTS-17.01.03-A1-6.3.4)  B 2 端子弯曲强度测试 Fig. 3 表 3 端子弯曲强度施加力  端子材料厚度/mm 施力值/N					
Low voltage current tolerance $ \begin{array}{c} \text{The initial: } \leq 5 \text{ m}\Omega \\ \text{Environmenttal resisance test} \\ \text{period/later: } \leq 10 \text{ m}\Omega \\ \end{array} $				◎ 0.20 4 ○ 0.30 10 ○ 0.40 15 ○ 0.40 20 □ Enter 10mA current at the opening of the maximum 20mV and calculate the contact resistance. (CTS-17.01.03-A1-6.4.2)				



#### TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: 6 OF 9 Measured by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connectors. Fig.4 Condition DC 500 V. (CTS-17.01.03-A1-6.4.4) 100 M  $\Omega$  Min.(Init ial) Insulation Resistance 100 M Ω Min. (Final) Fig.4 Test between adjacent circuits of mated / unmated connectors. Fig.5 Apply 1000 V AC of commercial frequency for 1 min. (CTS-17.01.03-A1-6.4.5) No discharge, flashover or Dielectric Withstanding breakdown. Voltage Current leakage: 1 mA max. (Dielectric Strength) 图 9 绝缘电阻测试 Fig 5. After having a half number of contacts series-wired (AVSS 0.5mm<sup>2</sup>), apply the specified current to the connector in the draft-free test chamber, and after reaching the established temperature, measure the temperature of the wire crimp of the contact. Imax. =8A (0.5mm² wire) a: pass the Imax. through the connector b:Pass the Imax.\*Kd through all theholes in the connector. (CTS-17.01.03-A1-6.4.3) 30° C, max. Temperature rise Kd: under loaded specified current 9到12 0, 5 Take an embedded connector, wire selection max wire diameter,put the connector water dry in the no-wind condition, and input the corresponding current and length in the following table . (CTS-17.01.03-A1-6.5.1 )  $\,$ Current load: Over The appearance meets the 線徑/mm2 电流 A 时间 sheath to change slightly **Current Loading** 16.5 60 min 20.5 200s 0.5 22.5 10s 30 1s



TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17	REVISION: E	ECN No: 1811330	PAGE: <b>7</b> OF <b>9</b>
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		•									
See Product Qualification and		At room tem terminal and listed in table (CTS-17.01.03 滑动距离 0.23mm	the female e :		T路电压 最大20 mV	通电电流 10 mA					
		MECHAI	NICAL								
Terminal holding force (Female Conn.)	(Comp 類型(W* 0.64*0.6- 1.0*0.64		Will be a bet within the sh speed drawi pressure par the sheath w (CTS-17.01.0	neath,and the wife of the wife of 100m when pulled	hen in the s vire,try poin nm,measuu I of .	shaft up to 5 t distance te	0mm/min erminal				
Mating Force	91235 70N M 78N M 92235 90N M 92237 65N M 85N M	/92235/92239 SERIES Max(40Pin below) fax.(40pin) MAX(32PIN)	Measure the locking latel (CTS-17.01.0	e force rec h by opera	quired to m ting at 50						
Unmating Force	70N M 78N M 92235 90N M 92237 65N M 85N M	IAX(32PIN)	Measure the force required to unmate connector without locking latch set in effect, by operating at 50 mm a minute.  (CTS-17.01.03-A1-6.3.11)								
Strength of lock	100N		A pair interlesolid measure 50mm/min with the junction According to direction and direction tilt of unlocked (CTS-17.01.0 meets the (N	urement from the end of the connumber of the connumber of the east	om the othernd is fixed end is fixed lector lock to the surfacient way to g 6.	er end at a I and the de structure, ir ace of the fi o make the	speed of evice is in the axial ve				



ASE DATE: 2018.10.17	REVISION: E	ECN No: 1811330	PAGE: <b>8</b> OF <b>9</b>			
702 57112. 2010.1111	112110101111	201110. 1011000	171GE. 2 3. C			
		Fig In a embedded with termi				
Unlock the force	20N Max	the connector after the ir most easy to lock in tecton load,measure the lock or moment, Fig 7. (CTS-17.01.	nsert lock structure, at a circ unlock on the connect unlock the required local local (03-A1-6.3.13)			
		Fig 7.				
Durability	Termination Resistance (Low Level)(Final) 0.5mm $^2$ 10m $\Omega$ max.	Mate and unmate connectors (CTS-17.01.03-A1-6.6.2)	s for 50 Cycles.			
Terminal holding force (Female Conn.)	(initial) 40N Min. (Completely locked) 100 Min.  類型(W*T) {代號} 初次鎖止狀態 完全鎖止狀態 0.64*0.64*(025) ≥40 ≥100 * □(四十年) □(	Will be a better terminal and within the sheath, and then in speed drawing of the wire, try pressure parte of 100mm, methe sheath when pulled of .(0	the shaft up to 50mm/mi point distance terminal easuuring terminal load fro			
Mechanical shock	Transient breaking time≤1ms See Product Qualification and Test Sequence Group G	Take a pair of connectors viselect the maximum diame adaptor. All hole series, and bench, up/down, left/right be 980m/s² acceleration, Thre direction, 10ms at a time, F (CTS-17.01.03-A1-6.6.4)	with full terminals, and ter of the terminal install it on the impact to fore/back with six direct e times in each ig 8.			
Vibration	Transient breaking time≤1ms See Product Qualification and Test Sequence Group F/4	Connector, and give vibration gold:below 20mV,10mA) ise Accelation / frequency as shup/down,left/right before/bac hours respectively. Fig 9.(CT	n after 12V,1A(for plated energized.,Vibration nown in Fig.4 and k with six direction for 6			



TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: **9** OF **9** 

	直接插入式护套。
	5~15 Hz 15~25 Hz 25~100 Hz 100~200 Hz 10 mm (p-p) 44.1 m/s² 19.6 m/s² 4.9 m/s²
Terminal / Housing	Apply axial pull out force at the speed rate of 25.4 ±

Retention Force 19.6N Min. (Wafer Conn.)

3 mm/minute. On the terminal assembled in the housing.

### **ENVIRONMENTAL**

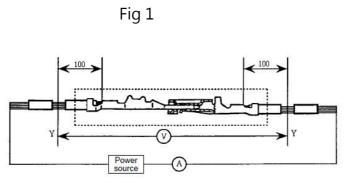
	LIVIIIONIMENTAL									
Item	Requirement	Standard								
Resistance to Wave Soldering Heat(Female Conn.)	See Product Qualification and Test	Solder Temp. : 265±5°C, 10±0.5sec.								
Humidity	See Product Qualification and Test Sequence Group 5	Mated Connector 40°C, 90 (EIA-364-31, Condition A, Meth	*							
Solder ability	Solderable area shall have solder coverage of 95% minimum.	After immersing a soldering ar posts in flux (rosineous metha seconds, immerse it in a solde (tin 60% lead 40%) for 3±0. 5 the connector by using approx	nol solution) for 5 to 10 ering bath of 230° C±5° C seconds,and then inspect							
Low Temperature test	See Product Qualification and Test Sequence Group 7	Subject mated connectors t <sup>™</sup> for 96 hours. Measure S								
Heat resistance	See Product Qualification and Test Sequence Group F/8	Take a pair of connectors we maximum diameter of the to 100±3°C high temperature I waterproof connector, strapp 30°, The tilt of the tilt is tilted 30N negative. After the test connector is removed and a temperature. (CTS-17.01.03	erminal fitting.Put it in the box in the test 120h,in type ping all wires,to make it to I to the waterproof bolt,plus is completed,the adjusted to room							
Thermal Shock	See Product Qualification and Test Sequence Group D	Take a pair of connectors will insert, and the wire is selected diameter of the terminal tong cold strike type of connector test are shown in table ,300 During the test, check the teacurrent, and the impedance flat should not exceed $7\Omega$ , After connector will be removed an after 2h , Fig 10.(CTS-17.01.0) [高温/C(high temperature/C)]	d with the most flattering gue, As shown in figure in the try humming gartic street repeat cycle. ansient condition of the luctuation of the connector the test is completed, the nd the connector will be left							

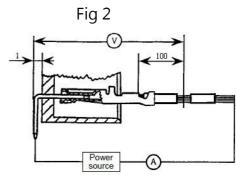


TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: **10** OF **9** 

	T	→ \mp+ σ.						
		高温階段						
		普通溫度						
		0.5h						
		低溫階段						
		循環周期						
		Fig 10.						
		Mate module and subject to follow						
		Condition for 5 cycles.						
	See Product Qualification and Test	1 cycles:						
Thermal Shock (2)	Sequence Group 5	-40 +0/-3°C,30 minutes						
		+105 +3/-0°C,30 minutes						
		(EIA-364-32,test condition I)						
		, ,						
		Dip between 3 mm and top of solder tab of cap						
		housing assembly into solder bath (tin						
		60%,lead40%) at 250° C±5° C for 5±0.5 seconds						
Resistance to	No Physical damage shall occur. Tab	and lock into appearance and meas tab retention						
Solder Heat	retention force 9.8N min.	force as bellow.Measurements of tab retention for						
		cut tab at bending area after dipped and measure						
		the force of tab to move when pushing toward the						
		direction by arrow mark.						
		full colloit by allow mark.						







Aces P/N: 91235 series / 92235 series/92237

series / 92410 series / 92239 series

TITLE: 2.2MM PITCH WTB WAFER CONN.

RELEASE DATE: 2018.10.17 REVISION: E ECN No: 1811330 PAGE: **11** OF **9** 

### 6 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group															
Test or Examination		c	A	C	D	F	G	1	2	3	4	5	6	7	8	9
		Test Sequence														
Examination of Product	1	1	1,5	1,4	1,10	1,5	1,3					1 . 7		1 . 6	1 . 6	
Hand feeling	6				8											
Voltage Drop									1 \ 5		1 \ 3	2 \ 10		2 . 9	2 . 9	
The bending strength of terminal	8															
Insulation Resistance												3、9		3 . 8	3、8	
Over Current Loading			3													
Resistance to slow sliding				2												
Dielectric Withstanding Voltage												4、8		4 \ 7	4 . 7	
Temperature rise	4							1								
Low voltage current tolerance	3		2,4	3	3,5,7	2										
Mating / Unmating Forces	2,5				2				2 \ 4							
Strength of lock		3								1						
Terminal / Housing Retention Force													1			
Durability					4				3							
Terminal holding force	7				9											
Vibration						4					2					
Mechanical shock							2									
Thermal Shock					6											
Thermal Shock(2)												5				
Unlock the force		2														
Humidity												6				<u> </u>
Solder ability																1
Low Temperature test														5		
Heat resistance						3									5	
Sample Size	3	3	3	3	3	3	3	5	5	5	5	5	5	5	5	5